

# Multilayer Chip Beads(SMD Array)

For signal line

## MZA series

Type:	MZA1210	[0504 inch]* (2 lines)
	MZA2010	[0804 inch] (4 lines)

\* Dimensions Code JIS[EIA]

Issue date: May 2011

- All specifications are subject to change without notice.
  - Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
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# Chip Beads(SMD Array) For General Signal Line

Conformity to RoHS Directive

## MZA Series MZA1210 Type

### FEATURES

- A single MZA series chip provides noise attenuation for two lines, making it ideal for use with I/O lines of various highly miniaturized.
- Electronic equipment, such as portable products, which comprise high density circuitry.
- Low crosstalk between adjacent circuits.
- Internal electrodes feature low DC resistance, minimizing wasteful power consumption.
- Electroplated terminal electrodes accommodate reflow soldering.
- Monolithic structure ensures high reliability.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

### APPLICATIONS

Removal of signal line noises of cellular phones, PCs, note PCs, TVs, DVDs, DSCs, game machines, digital photo frames, PNDs, etc.

### PRODUCT IDENTIFICATION

MZA	1210	D	121	C	T
(1)	(2)	(3)	(4)	(5)	(6)

- (1) Series name
- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance  
121:120Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style  
T:Taping

### HANDLING AND PRECAUTIONS

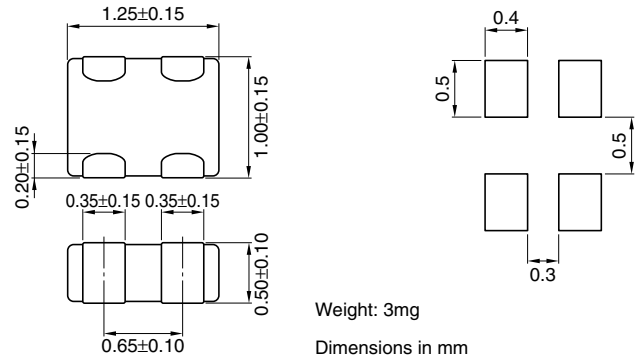
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.
- This product does not apply to flow soldering construction method.

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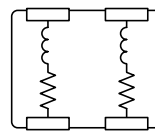
• Please contact our Sales office when your application is considered the following:  
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

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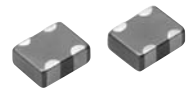
### SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



### CIRCUIT DIAGRAM



• No polarity



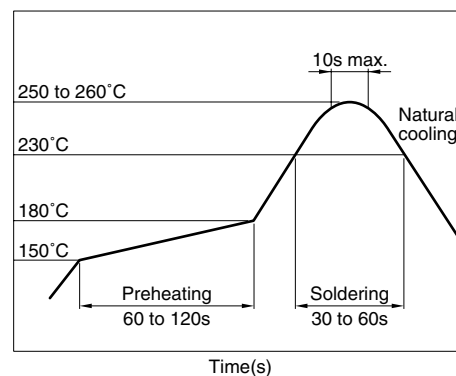
### TEMPERATURE RANGES

Operating/storage	-55 to +125°C
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### PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	5000 pieces/reel

### RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



### ELECTRICAL CHARACTERISTICS

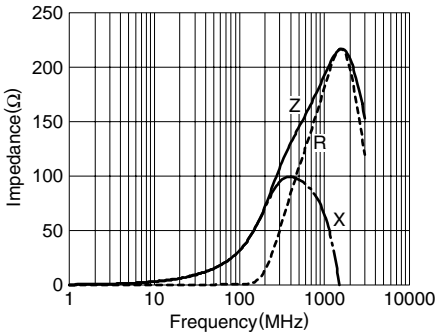
Part No.	Impedance ( $\Omega$ )[100MHz]*	DC resistance ( $\Omega$ )max.	Rated current (mA)max.	Rated voltage (V)max.
MZA1210D330C	33 $\pm$ 25%	0.30	50	5
MZA1210D680C	68 $\pm$ 25%	0.50	50	5
MZA1210D121C	120 $\pm$ 25%	0.80	50	5
MZA1210D241C	240 $\pm$ 25%	1.20	50	5

\* Test equipment: E4991A or equivalent  
 Test tool: 16192A or equivalent  
 Test temperature: 25 $\pm$ 10°C

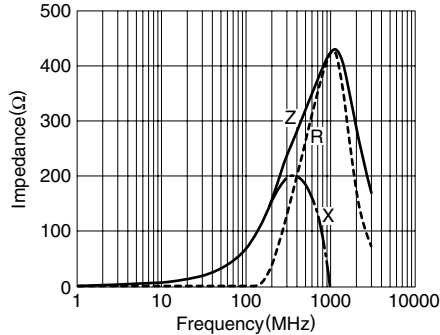
### TYPICAL ELECTRICAL CHARACTERISTICS

#### Z, X, R vs. FREQUENCY CHARACTERISTICS

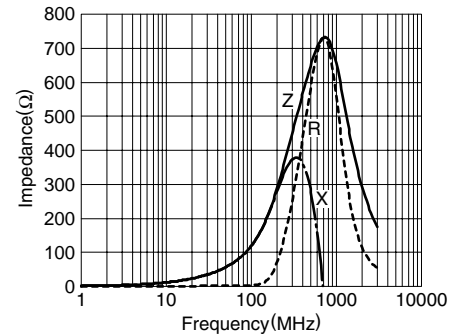
#### MZA1210D330C



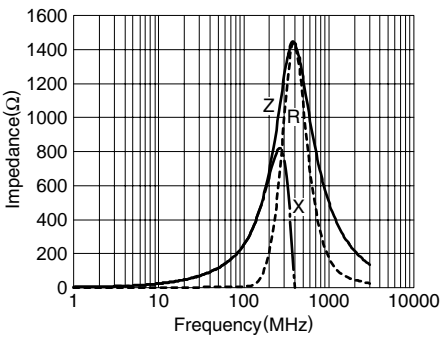
#### MZA1210D680C



#### MZA1210D121C

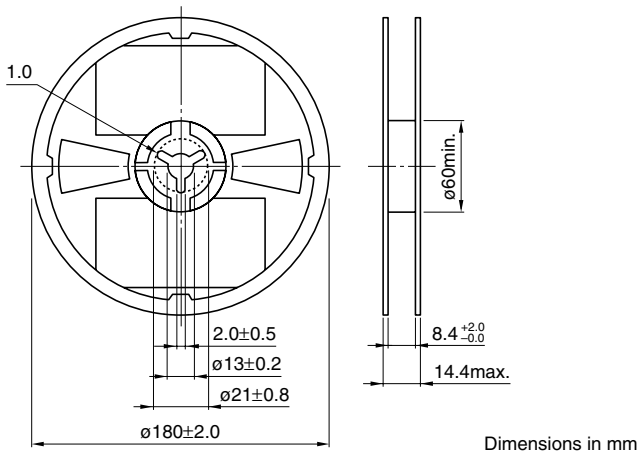


#### MZA1210D241C



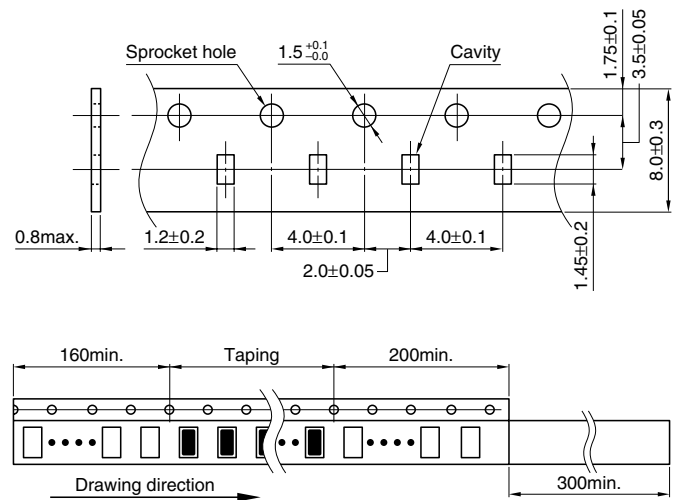
### PACKAGING STYLES

#### REEL DIMENSIONS



Dimensions in mm

#### TAPE DIMENSIONS



Dimensions in mm

• All specifications are subject to change without notice.

# Chip Beads(SMD Array) For General Signal Line

Conformity to RoHS Directive

## MZA Series MZA2010 Type

### FEATURES

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- It is a product conforming to RoHS directive.

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- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance  
121:120Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style  
T:Taping

### HANDLING AND PRECAUTIONS

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### MATERIAL CHARACTERISTICS

**B material:** This type is perfectly suited for fast digital signals. By equalizing R components and X components that beads possess at a frequency of 5MHz, it is able to suppress overshooting, undershooting and ringing of fast digital signals.

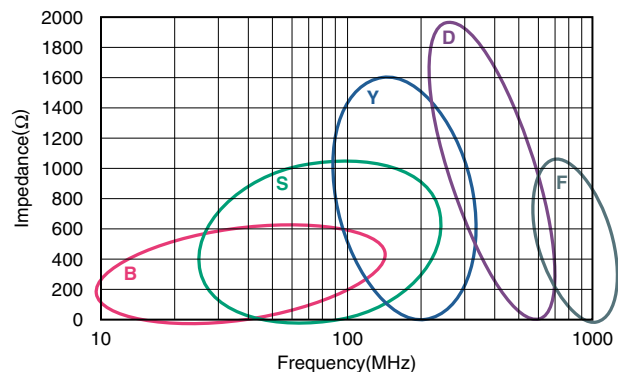
**S material:** Standard type that features impedance characteristics similar to those of a typical ferrite core.  
For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

**Y material:** High frequency range type intended for the 100MHz region and above.  
For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

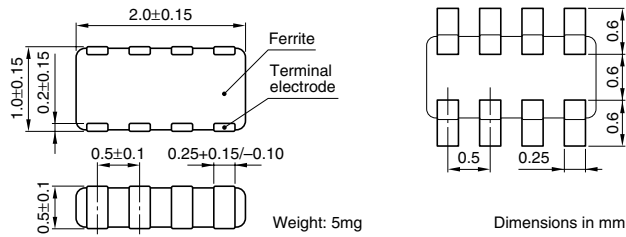
**D material:** For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies. Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

**F material:** This new product inherits the characteristic of our D-material, namely its sharp impedance rise time, and its impedance peak frequency has been shifted higher into range. The product offers excellent noise suppression from 600MHz to as high as in the GHz range.

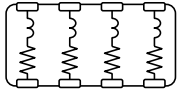
### TYPICAL MATERIAL CHARACTERISTICS



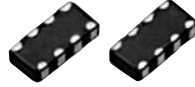
## SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



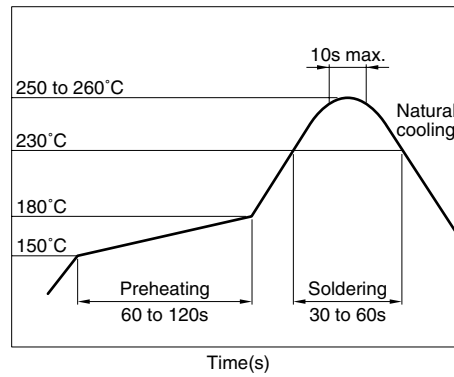
## CIRCUIT DIAGRAM



• No polarity



## RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



## TEMPERATURE RANGES

Operating/storage -55 to +125°C

## PACKAGING STYLE AND QUANTITIES

Packaging style Quantity  
Taping 5000 pieces/reel

## ELECTRICAL CHARACTERISTICS

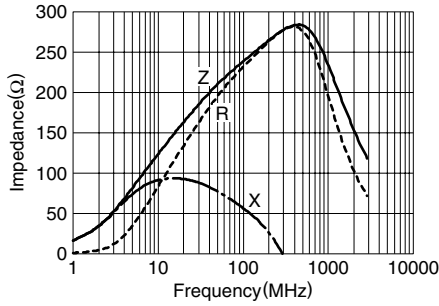
Part No.	Impedance ( $\Omega$ )[100MHz]*	DC resistance ( $\Omega$ )max.	Rated current (mA)max.	Rated voltage (V)max.
MZA2010B241C	240±25%	0.45	100	5
MZA2010S800C	80±25%	0.22	100	5
MZA2010S121C	120±25%	0.25	100	5
MZA2010S241C	240±25%	0.35	100	5
MZA2010S601C	600±25%	0.50	100	5
MZA2010S102C	1000±25%	0.75	100	5
MZA2010Y800C	80±25%	0.30	100	5
MZA2010Y121C	120±25%	0.40	100	5
MZA2010Y241C	240±25%	0.60	100	5
MZA2010Y601C	600±25%	0.80	100	5
MZA2010Y102C	1000±25%	1.00	100	5
MZA2010D330C	33±25%	0.30	50	5
MZA2010D680C	68±25%	0.50	50	5
MZA2010D121C	120±25%	0.80	50	5
MZA2010D241C	240±25%	1.20	50	5
MZA2010F330C	33±25%	0.60	100	5
MZA2010F470C	47±25%	0.80	100	5
MZA2010F560C	56±25%	0.80	100	5

\* Test equipment: E4991A or equivalent  
Test tool: 16192A or equivalent  
Test temperature: 25±10°C

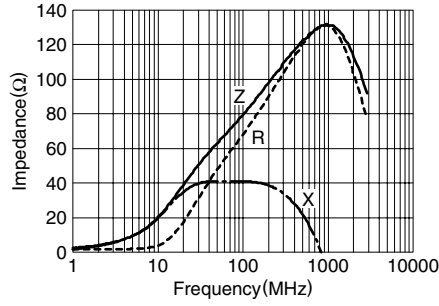
**TYPICAL ELECTRICAL CHARACTERISTICS**

**Z, X, R vs. FREQUENCY CHARACTERISTICS**

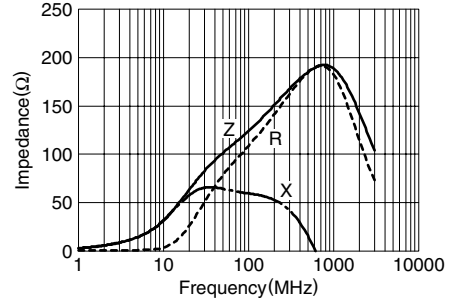
**MZA2010B241C**



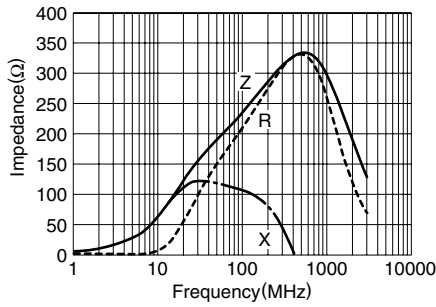
**MZA2010S800C**



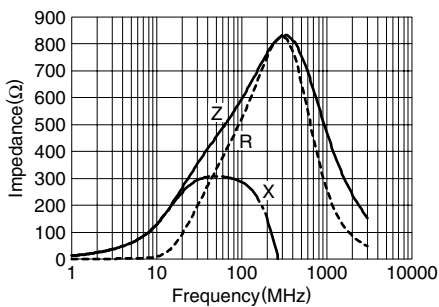
**MZA2010S121C**



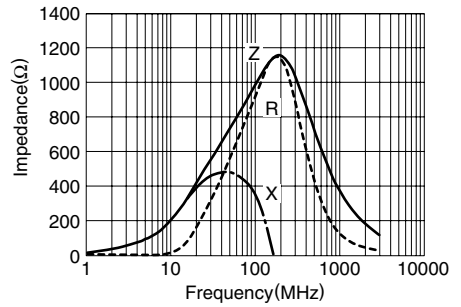
**MZA2010S241C**



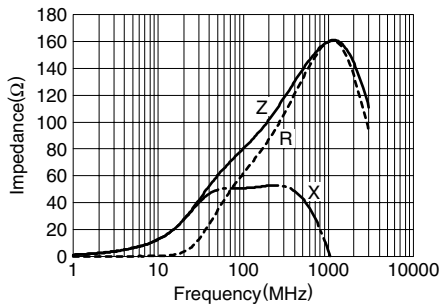
**MZA2010S601C**



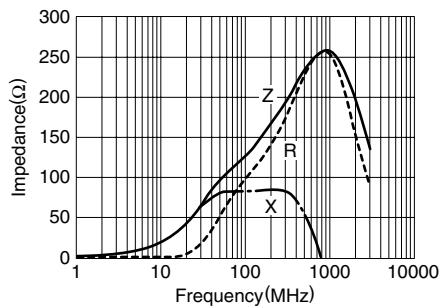
**MZA2010S102C**



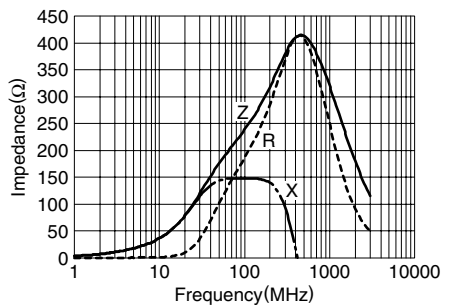
**MZA2010Y800C**



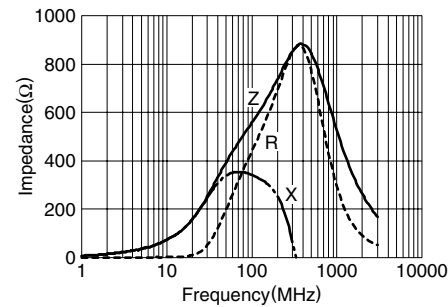
**MZA2010Y121C**



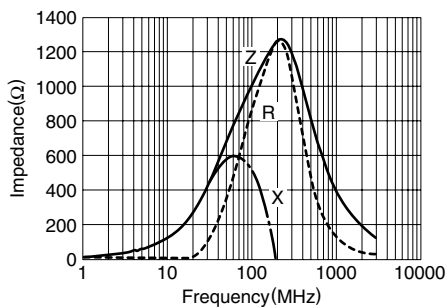
**MZA2010Y241C**



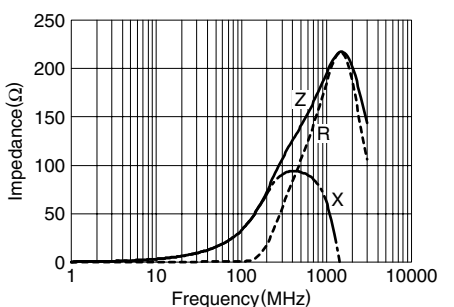
**MZA2010Y601C**



**MZA2010Y102C**



**MZA2010D330C**

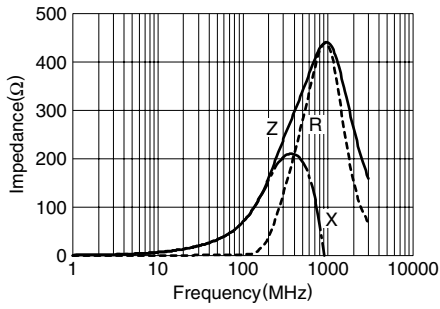


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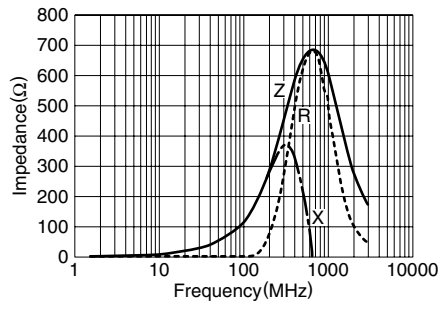
### TYPICAL ELECTRICAL CHARACTERISTICS

#### Z, X, R vs. FREQUENCY CHARACTERISTICS

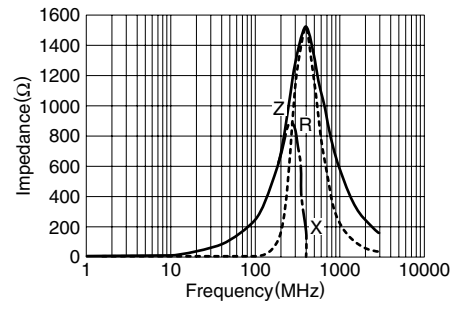
##### MZA2010D680C



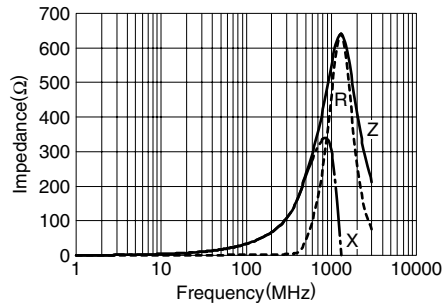
##### MZA2010D121C



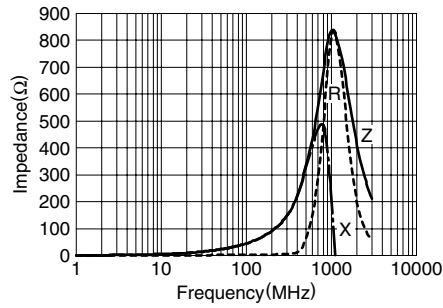
##### MZA2010D241C



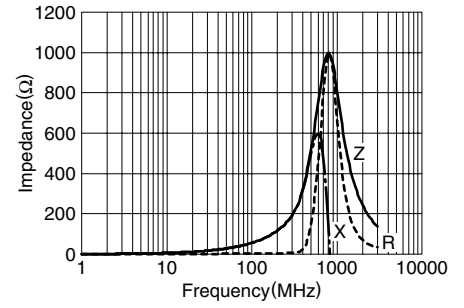
##### MZA2010F330C



##### MZA2010F470C

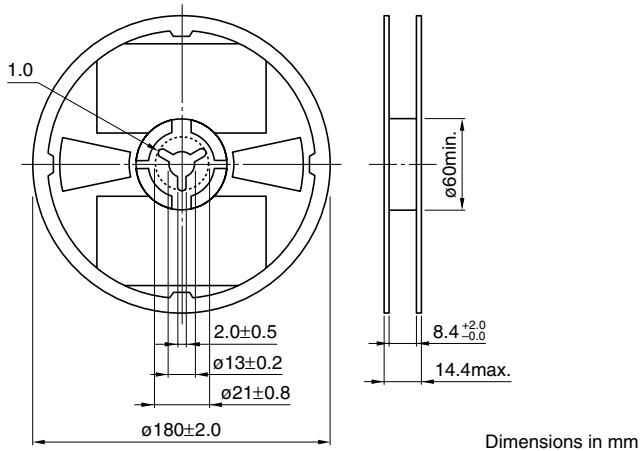


##### MZA2010F560C



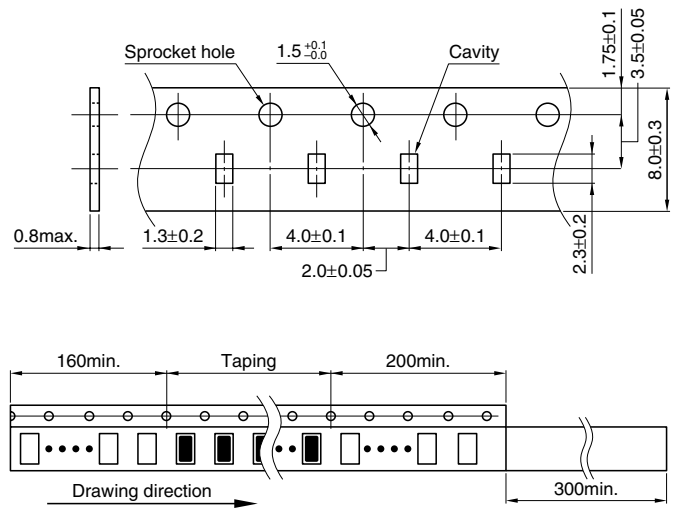
### PACKAGING STYLES

#### REEL DIMENSIONS



Dimensions in mm

#### TAPE DIMENSIONS



Dimensions in mm

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